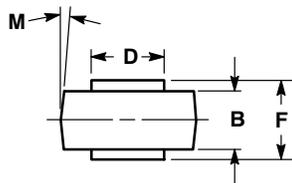
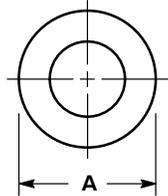


SCALE 1:1

**MICRODE  
CASE 193-04  
ISSUE L**

DATE 22 SEP 2003



NOTES:

- CASE 193-03 OBSOLETE, NEW STANDARD 193-04.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.43	8.69	0.332	0.342
B	4.19	4.45	0.165	0.175
D	5.54	5.64	0.218	0.222
F	5.94	6.25	0.234	0.246
M	5 °NOM		5 °NOM	

**GENERIC  
MARKING DIAGRAM\***



- DEV = Specific Device Code
- A = Assembly Location
- YY = Year
- WW = Work Week

\*This information is generic. Please refer to device data sheet for actual part marking.

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<b>DESCRIPTION:</b>	<b>CASE 193-04, MICRODE</b>	<b>PAGE 1 OF 1</b>

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